

100V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max Tc = +25°C
100V	8mΩ @ V _{GS} = 10V	90A
1000	$12.5m\Omega @ V_{GS} = 4.5V$	74A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R_{DS(ON)} yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switches.

Applications

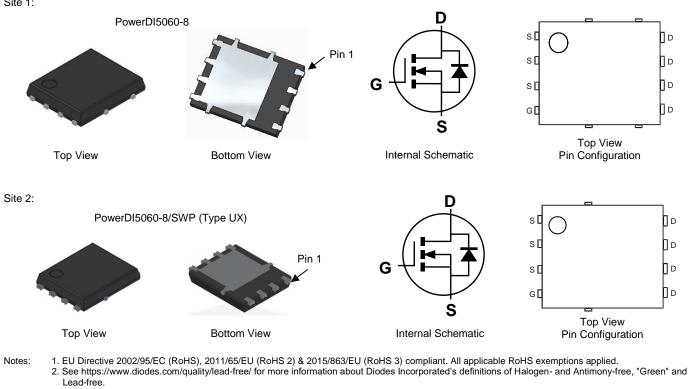
- Motor controls
- **DC-DC** converters
- Power management

Features

- Thermally Efficient Package-Cooler Running Applications
- **High Conversion Efficiency**
- 100% Unclamped Inductive Switching (UIS) Test in Production -• Ensures More Reliable and Robust End Application
- Low RDS(ON) Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- < 1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

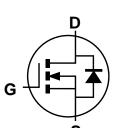
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.097 grams (Approximate)



3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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Site 1:



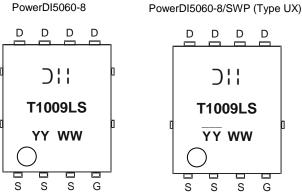


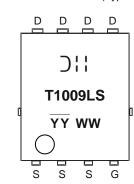
Ordering Information (Note 4)

Part Number	Backago	Packing		
Fait Nulliger	Package	Qty.	Carrier	
DMT10H009LPS-13	PowerDI5060-8	2,500	Tape & Reel	
DMITTOHOO9EF3-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note: 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





) | | = Manufacturer's Marking T1009LS = Product Type Marking Code YYWW or $\overline{YY}WW = Date Code Marking$ YY or \overline{YY} = Last Two Digits of Year (ex: 23 = 2023) WW = Week Code (01 to 53)

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	100	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current V _{GS} = 10V (Note 5)	Steady State	T _A = +25°C T _A = +70°C	١D	10 8	A
Continuous Drain Current V _{GS} = 10V (Note 6)	Steady State	Tc = +25°C Tc = +70°C	١D	90 72	А
Pulsed Drain Current (10µs Pulse, T _C = +25°C, Package Limited)			IDM	360	A
Maximum Continuous Body Diode Forward Current			ls	85	A
Pulsed Body Diode Current (10µs Pulse, Tc = +25°C, Package Limited)			lsм	360	A
Avalanche Current (Note 7), L = 0.3mH			I _{AS}	21	A
Avalanche Energy (Note 7), L = 0.3mH			Eas	66	mJ
V _{DS} Spike, L = 0.1mH t = 10µs			VSPIKE	110	V

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 8)	T _A = +25°C	PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	R _{0JA}	98	°C/W
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.9	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	43	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	104	W
Thermal Resistance, Junction to Case (Note 6)		R _{0JC}	1.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_{J} = +25°C.

8. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Notes:



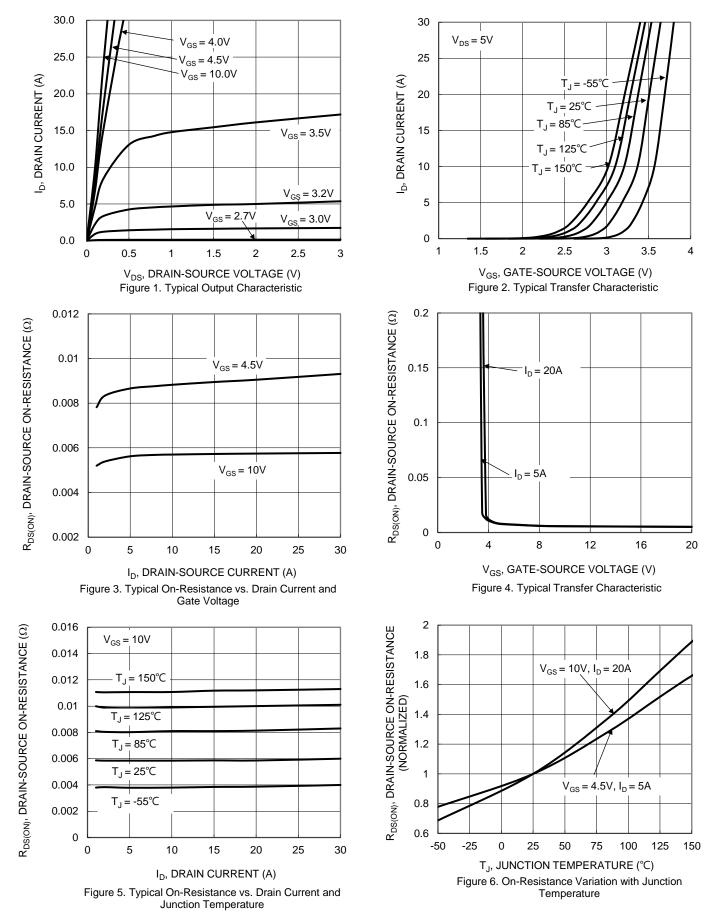
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)	Cymbol	WIIII	Typ	Max	Onit	Test condition	
Drain-Source Breakdown Voltage	BVpss	100	_		V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)			•		•	÷	
Gate Threshold Voltage	Vgs(th)	1.2	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Statia Duaia Causa On Desistance	D		6	8	mΩ	V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	9	12.5	1117	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	Vsd	—	0.8	1.2	V	V _{GS} = 0V, I _S = 13A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	2309	—	pF	$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	_	536	_			
Reverse Transfer Capacitance	Crss	—	13.7	—			
Gate Resistance	Rg	—	1.9	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	—	40.2			V _{DD} = 50V, I _D = 20A	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	20.2	—	nC		
Gate-Source Charge	Qgs	—	7.0	—	ne		
Gate-Drain Charge	Q _{gd}	—	8.5				
Turn-On Delay Time	tD(ON)	_	5.4	_		$V_{DD} = 50V, V_{GS} = 10V$ $I_D = 20A, R_g = 3\Omega$	
Turn-On Rise Time	tR	_	10.6	_	ns		
Turn-Off Delay Time	tD(OFF)	_	28.3	_			
Turn-Off Fall Time	tF		14.9	_]		
Reverse Recovery Time	trr	_	44.3	_	ns	1 = -200 dl/dt = 1000/uc	
Reverse Recovery Charge	Qrr		65.5	_	nC	$I_F = 20A, dI/dt = 100A/\mu s$	

Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



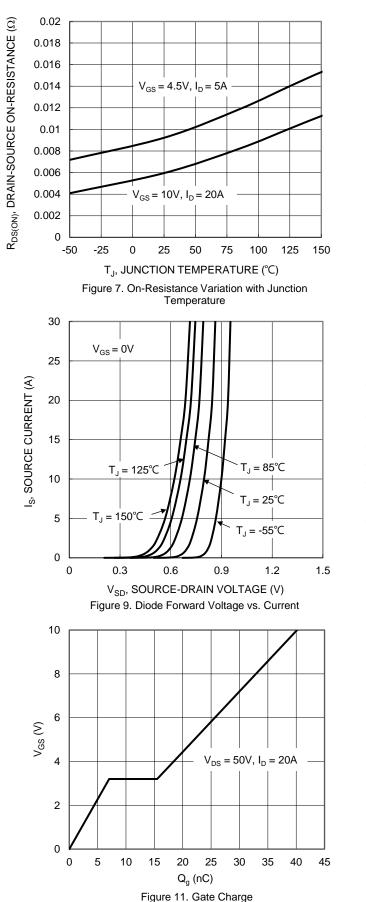
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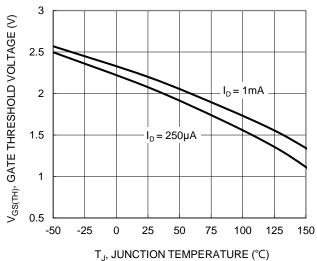
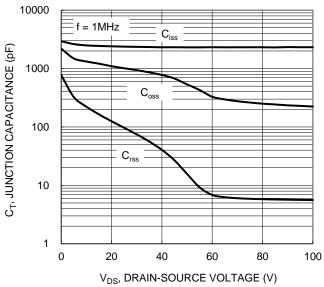
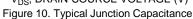
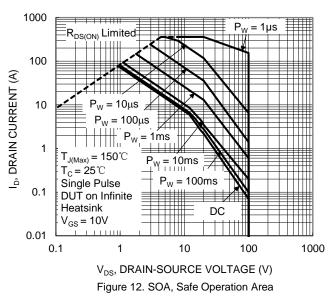


Figure 8. Gate Threshold Variation vs. Junction Temperature



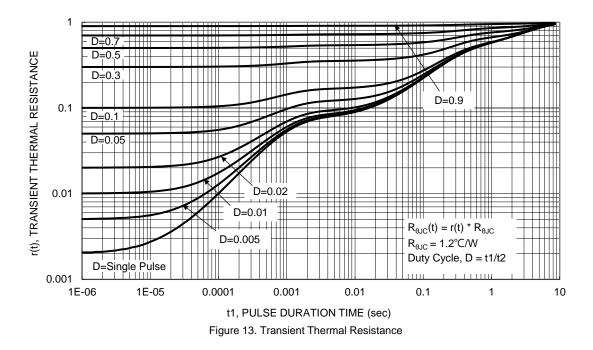




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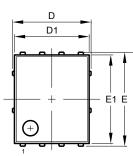


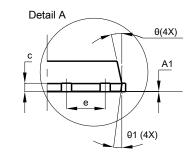
Package Outline Dimensions

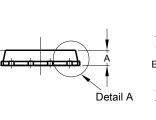
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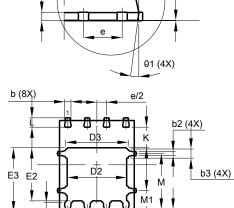
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Site 1:



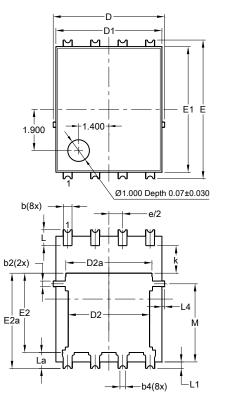






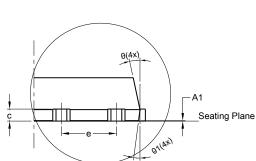
	PowerDI5060-8				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E		6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е		1.27 BSC	;		
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
Al	All Dimensions in mm				

Site 2:

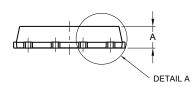


PowerDI5060-8/SWP (Type UX)

PowerDI5060-8



DETAIL A



	PowerDI5060-8/SWP (Type UX)			
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	-	
С	0.230	0.330	0.277	
D	5	.15 BS0	C	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	2	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	.27BSC	<u>) </u>	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0	.050RE	F	
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

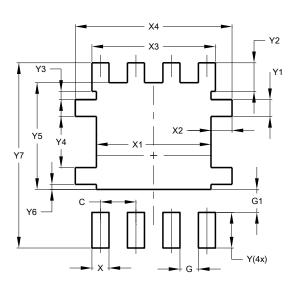
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Suggested Pad Layout

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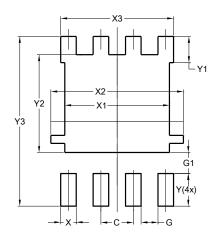


Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	5.190
X3	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610

DMT10H009LPS

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